

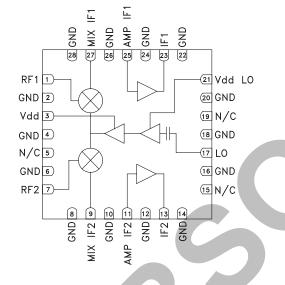


#### **Typical Applications**

The HMC381LP6 / HMC381LP6E is ideal for Wireless Infrastructure Applications:

- GSM, GPRS & EDGE
- CDMA & W-CDMA
- PHS & PDC
- WiMAX

#### **Functional Diagram**



# HMC381LP6 / 381LP6E

# HIGH IP3 RFIC DUAL DOWNCONVERTER, 1.7 - 2.7 GHz

#### Features

Input IP3: +27 dBm Low Single Input LO Drive: 0 dBm Conversion Gain: 9 dB Noise Figure: 12 dB Single Positive Supply: +5V @ 260 mA

#### General Description

The HMC381LP6 & HMC381LP6E are high linearity Dual Down Converter Receiver ICs that operate from 1.7 - 2.7 GHz and deliver a +27 dBm input third order intercept point for UMTS, PHS and WiMAX applications. The passive mixer outputs and high dynamic range IF amplifier inputs are positioned so that an external IF filter can be placed in series between them. The converter provides a gain of 9 dB and 12 dB typical single side band noise figure. The IC operates from a positive +5V rail consuming 260 mA of current while requiring a LO drive level of only -4 to +4 dBm. The design requires no external baluns and supports IF frequencies between 50 and 300 MHz.

#### Electrical Specifications, $T_{A} = +25^{\circ}$ C, LO = 0 dBm, Vdd = 5V

Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range, RF		1.7 - 2.0			2.0 - 2.2			2.5 - 2.7		GHz
Frequency Range, LO		1.4 - 2.3			1.7 - 2.5			2.2 - 2.6		GHz
Frequency Range, IF		50 - 300 [	1]		50 - 300 [1	]		50 - 300 <sup>[2</sup>	2]	MHz
Conversion Gain	6.5	8.5		7	9		7	9		dB
Noise Figure (SSB)		12			12.5					dB
LO to RF Isolation		11			11			5		dB
LO to IF Isolation	16	20		14	18		13	18		dB
RF to IF Isolation	30	40		40	46		32	37		dB
IP3 (Input)	23	26		24	27		23	26		dBm
1 dB Compression (Input)		12			12			10		dBm
Branch Isolation		50			52			50		dB
LO Drive Input Level (Typical)		-4 to +4			dBm					
Supply Current (Idd for LO & IF) (IF bias resistor= 4.7 Ohms)		260	330		260	330		260	330	mA

[1] Unless otherwise noted all measurements with low side LO & IF = 250 MHz.

[2] Unless otherwise noted all measurements with low side LO & IF = 156 MHz.

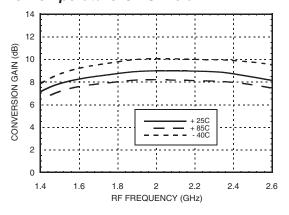
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## HIGH IP3 RFIC DUAL DOWNCONVERTER, 1.7 - 2.7 GHz

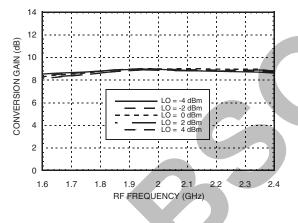


Conversion Gain vs. Temperature @ LO = 0 dBm

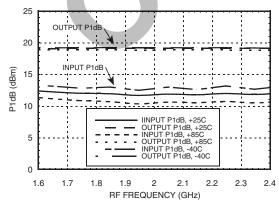


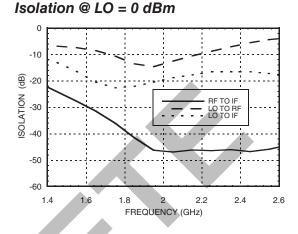
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Conversion Gain vs. LO Drive

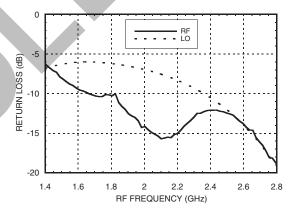


P1dB vs. Temperature @ LO = 0 dBm

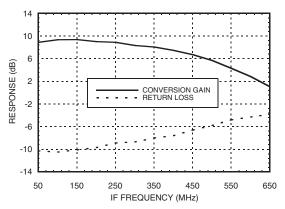




Return Loss @ LO = 0 dBm



IF Bandwidth @ LO = -5 dBm



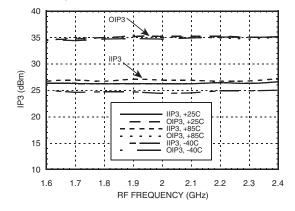
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For price, delivery, and to place orders: Analog Devices, Inc., One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106 Phone: 781-329-4700 • Order online at www.analog.com Application Support: Phone: 1-800-ANALOG-D 8

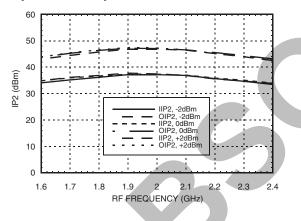




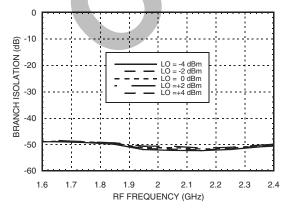
Input and Output IP3 vs. Temperature @ LO = 0 dBm



Input and Output IP2 vs. LO Drive



Branch Isolation RF1 - IF2 vs. LO Drive IF = 250 MHz



#### Reference to output of standard path

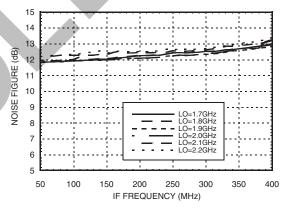
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## HIGH IP3 RFIC DUAL DOWNCONVERTER, 1.7 - 2.7 GHz

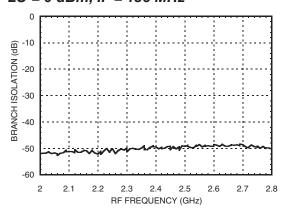
Input and Output IP3 vs LO Drive

40 OIP3 35 30 IP3 (dBm) 25 • IIP3, -2 dBm OIP3, -2 dBm IIP3, 0 dBm OIP3, 0 dBm IIP3, +2 dBm OIP3, +2 dBm 20 ..... 15 1.7 1.9 2.1 22 24 1.6 18 2 23 **RF FREQUENCY (GHz)** 

Noise Figure vs. IF Frequency



Branch Isolation RF1 - IF2 LO = 0 dBm, IF = 156 MHz



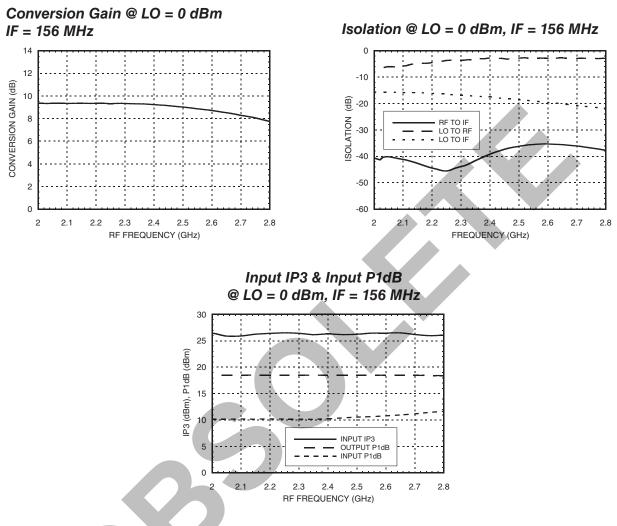


DOWNCONVERTER, 1.7 - 2.7 GHz

**HIGH IP3 RFIC DUAL** 

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#### **MxN Spurious @ IF Port**

			nLO	nLO	
mRF	0	1	2	3	4
0	хх	21	52	40	48
1	54	0	57	82	88
2	95	79	53	84	94
3	94	94	95	72	95
4	94	95	94	95	95
BE Freq = 1.9 GHz @ -10 dBm					

LO Freq. = 1.65 GHz @ 0 dBm

All values in dBc relative to the IF power level.

#### Harmonics of LO

	nLO Spur @ RF Port				
LO Freq. (GHz)	1	2	3	4	
1.4	8	12	15	19	
1.5	9	13	16	21	
1.6	11	14	17	24	
1.7	13	15	18	29	
1.8	12	13	19	29	
1.9	11	12	19	28	
LO = 0 dBm All values in dBc below input LO level measured at BE port					

II values in dBc below input LO level measured at RF bort.

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#### Absolute Maximum Ratings

+13 dBm
+15 dBm
+7 Vdc
150°C
1.64 W
39.6 °C/W
-65 to +150°C
-40 to +85°C
Class 1A

# HMC381LP6 / 381LP6E

# **HIGH IP3 RFIC DUAL** DOWNCONVERTER, 1.7 - 2.7 GHz

#### Typical Supply Current vs. Vdd

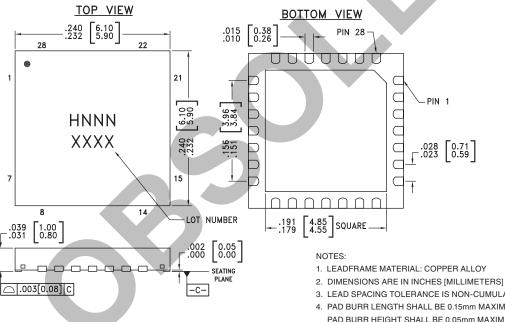
Vdd (LO + IF)	ldd (mA)
+4.5	190
+5.0	260
+5.5	340

Downconverter will operate over full voltage range shown above.



ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

## **Outline Drawing**



- 3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM.
- PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

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#### Package Information

-				
Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking <sup>[3]</sup>
HMC381LP6	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 <sup>[1]</sup>	H381 XXXX
HMC381LP6E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 <sup>[2]</sup>	<u>H381</u> XXXX

[1] Max peak reflow temperature of 235 °C

[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

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# HMC381LP6 / 381LP6E

**RoHS**√

## **HIGH IP3 RFIC DUAL** DOWNCONVERTER, 1.7 - 2.7 GHz

#### **Pin Descriptions**

Pin Number	Function	Description	Interface Schematic
1, 7	RF1, RF2	These pins are DC coupled and matched to 50 Ohms.	RF1 RF2
2, 4, 6, 8, 10, 12, 14, 16, 18, 20, 22, 24, 26, 28	GND	Backside of package has exposed metal ground slug that must also be connected to ground.	
3	Vdd	Power supply for the second stage LO amplifier. One external bypass capacitor (1,000 pF) is required.	Vdd O
5, 15, 19	N/C	No connection. These pins may be connected to RF ground. Performance will not be affected.	
9, 27	MIX IF2, MIX IF1	IF output from the mixers. This pin is DC coupled to the mixer. A low pass filter and blocking capacitor are required between mixer IF port and IF amplifier. (See application circuit).	MIX IF2
11, 25	AMP IF2, AMP IF1	Inputs to the IF amplifiers. A low pass filter and block- ing capacitor are required between mixer IF port and IF amplifier. (See application circuit).	AMP IF2 AMP IF1
13, 23	IF2, IF1	Outputs of the IF amplifiers and bias ports for the IF amplifiers. A pull up inductor, resistor, and bypass capacitors are required. (See application circuit).	
17	LO	These pins are AC coupled and matched to 50 Ohms.	
21	Vdd LO	Bias voltage for the first stage of the LO amplifier. A pull up inductor, resistor, and bypass capacitors are required. (See application circuit).	→ → Vdd L0

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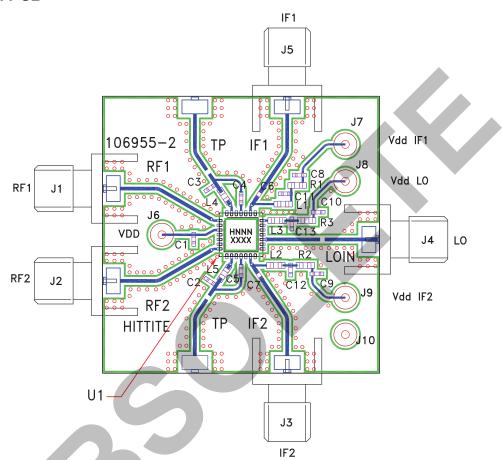


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## HIGH IP3 RFIC DUAL DOWNCONVERTER, 1.7 - 2.7 GHz



#### **Evaluation PCB**



#### List of Materials for Evaluation PCB 106971 [1]

Item	Description		
J1 - J5	PCB Mount SMA RF Connector		
J6 - J10	DC Pins		
C1, C4 - C10	1000 pF Chip Capacitor, 0402 Pkg.		
C2, C3	7 pF Chip Capacitor, 0402 Pkg.		
C11, C12, C13	100 pF Chip Capacitor, 0402 Pkg.		
L1, L2	220 nH Chip Inductor, 0603 Pkg.		
L3	22 nH Chip Inductor, 0603 Pkg.		
L4, L5	27 nH Chip Inductor, 0603 Pkg.		
R1, R2	4.7 Ohm Resistor, 0603 Pkg.		
R3	22 Ohm Resistor, 0603 Pkg.		
U1	HMC381LP6 / HMC381LP6E		
PCB [2]	106955 Evaluation Board		

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

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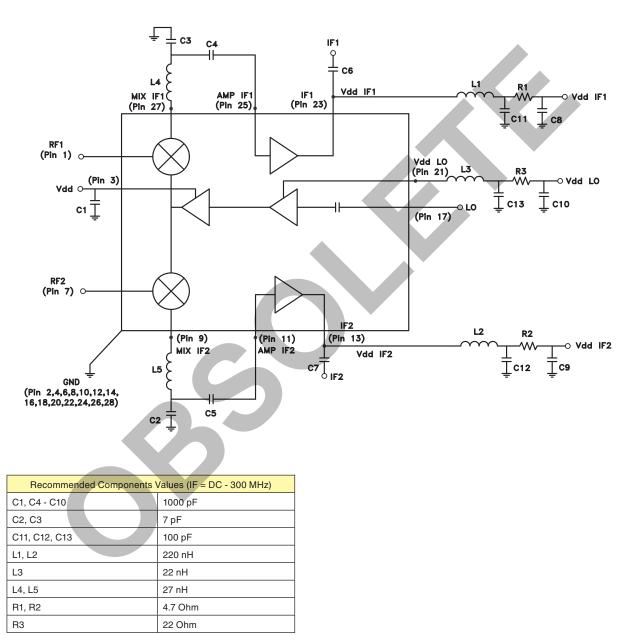


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# HIGH IP3 RFIC DUAL DOWNCONVERTER, 1.7 - 2.7 GHz



### Application Circuit



Note: L4, C3 and L5, C2 form low pass filters. C4 and C5 are DC blocks.

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